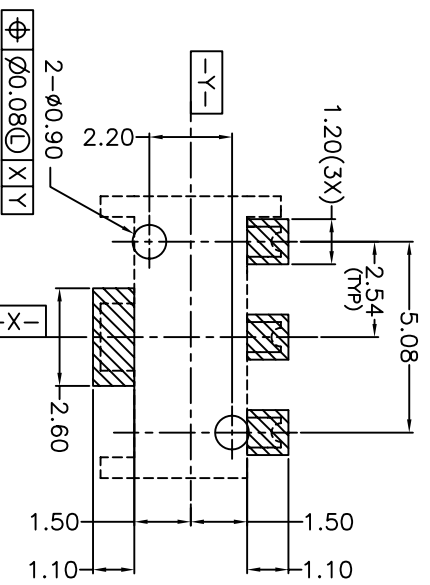


- SPECIFICATION:
- CURRENT RATING : 3A MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE : 350V AC R.M.S. FOR ONE MINUTE.
 - INSULATION RESISTANCE : 250 MΩ MIN AT 250V DC.
 - OPERATING TEMPERATURE : -40°C TO +85°C.
 - NORMAL FORCE : 110g MIN(working : 1.0mm)
 - SOLDER HEAT RESISTANCE : WAVE SOLDERING 260°C 10 SECS.
 - TO CONFORM TO THE SINGATRON HSF SPECIFICATION.
 - GREEN PRODUCT IDENTIFICATION MARK ON BODY:
 - GREEN PRODUCT IDENTIFICATION LABEL ON PACKAGING:
 - FOR WAVE SOLDERING LEAD-FREE PROCESS:



RECOMMENDED PCB LAYOUT
TOP VIEW(TOLERANCE ±0.05)

C	PAD	1	COPPER ALLOY,T=0.20mm	PLATING TIN AT ALL AREA PLATING NI UNDER PLATED OVER ALL
B	CONTACT	3	COPPER ALLOY,T=0.15mm	PLATING Au AT ALL AREA PLATING NI UNDER PLATED OVER ALL
A	BODY	1	HIGH TEMP	BLACK COLOR
NO DESCRIPTION		QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES				
DECIMALS:		ANGLES:	TITLE	
X	:±0.5	X	:±2°	DWN B07E 20080122 PART NO.2BA-903A-001
X,X	:±0.3	X,X	:±1°	CHKD SWHY 20080122 SCALE: 5/1 UNIT: mm
X,XX	:±0.2			APVD MW 20080122 SIZE: A3 SHEET:1 OF 1 REV: D

Singatron Enterprise Co., Ltd.
信昌企業股份有限公司

CUSTOMER COPY(SZ)

REV.	ECN NO OR DESCRIPTION	REVISED	DATE
C	ECN NO: S071017	BOYE	2007.11.05
D	ECN NO: S071112	BOYE	2008.01.22